The 'Gen-II' LAPPDTM: Large-Area Ceramic-Body Planar MCP-based Photo-Detectors

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Abstract

The Gen-II LAPPDTM is a $20 \times 20 \text{ cm}^2$ MCP-based photo-detector that has a monolithic ceramic detector base with an anode capacitively-coupled through a thin metal film to an application-specific readout pattern outside of the vacuum package. We discuss the development, including recent progress in producing a photo-cathode on the detector window using the *air-transfer* process. In this process a hermetic seal between the top window with pre-deposited antimony layer and the detector base is done during the detector bake-out. Photo-cathode synthesis is done by introducing alkali vapor into the sealed detector package through a small sealable vacuum port. We have demonstrated the feasibility of several critical process steps including demonstration of cesium transport from a source outside of the detector package to the entire surface of the detector window in the presence of two full-size $20 \times 20 \text{ cm}^2$ MCPs inside the detector.

Gen-II LAPPD™

Gen-II LAPPD development is a joint program between the University of Chicago and Incom Inc.

In-Situ Photo-Cathode Synthesis



(Left:) Top window view after bake-out prior to cesation. (Right:) Top window view after cesiation.



| | Gen-I | Gen-II |
|------------------|-----------------|-------------------------------|
| Detector base | Glass | Ceramic |
| Anode | Delay line | Capacitively-coupled |
| Assembly process | Vacuum transfer | Air-transfer (Chicago effort) |

- Gen-I LAPPDs are now commercially available through Incom Inc.
- Ceramic packaging and capacitively-coupled anode are already being implemented at Incom.
- Air-transfer assembly process is under development at the University of Chicago.

In parallel we are developing multi-channel electronics systems (PSEC4) to deploy these detectors in physics experiments, including ANNIE experiment and Fermilab Test-Beam.

Air-Transfer Process



(*Left:*) Air-transfer of the window with pre-deposited layer of Sb. (*Right:*) University of Chicago PSEC Lab with two vacuum processing chambers. Due to their compact size, potentially many chambers could be operated at the same time at a future LAPPD production facility, using a shared vacuum distribution system. Each vacuum processing chamber could accomodate several LAPPDs. This batch production strategy would be similar to PMT batch production.

In-situ photo-cathode synthesis showing photo-sensitivity expressed in arbitrary units. Direct measurement of photo-current and absolute QE were precluded since the photo-cathode, MCPs, and the anode were interconnected with an internal high-voltage divider as part of a simplified strategy to power the tile (see Refs. 2-3). Future devices will allow direct measurement of photo-current and calibrated QE.

Results and Conclusions



(*Left:*) Complete Gen-II LAPPD tile-21. (*Middle:*) Pulses from tile-21. (*Right:*) Final photo-sensitivity map of the tile-21 in arbitrary inits. Tile-21 was an early test of cesium transport. Improved photo-cathode uniformity is expected in future devices.

Demonstrated cesium transport from an external source to the entire surface of the detector window in the presence of two full-size 20×20 cm² MCPs inside the detector
MCPs are functional after exposure to cesium during the photo-cathode synthesis

The goal is to develop an inexpensive process scalable to a production rate of > 50 LAPPDs/week.

Bake-Out in Dual Vacuum

Bake-out of the detector vacum envelope and indium seal between the window and the detector body are done in the same heat cycle. The bake-out temperature of \sim 300 C exceeds indium melting temperature of \sim 157 C. A dual vacuum system is required to ensure mechanical and vacuum stability.



(*Left:*) Schematic view of the processing system that includes the dual-vacuum system and alkali transport system. (*Right:*) Typical bake-out and indium seal heat cycle.

References and Acknowledgments

References:

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